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(12) **United States Design Patent** (10) **Patent No.:** **US D978,106 S**
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(54) **BONE CONDUCTION EARPHONE**
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(30) **Foreign Application Priority Data**

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(52) **U.S. Cl.**
USPC **D14/205**

(58) **Field of Classification Search**
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381/380-381, 327, 379
CPC H04R 25/00; H04R 25/02; H04R 1/1066;
H04R 1/1016; H04R 5/033; H04R
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See application file for complete search history.

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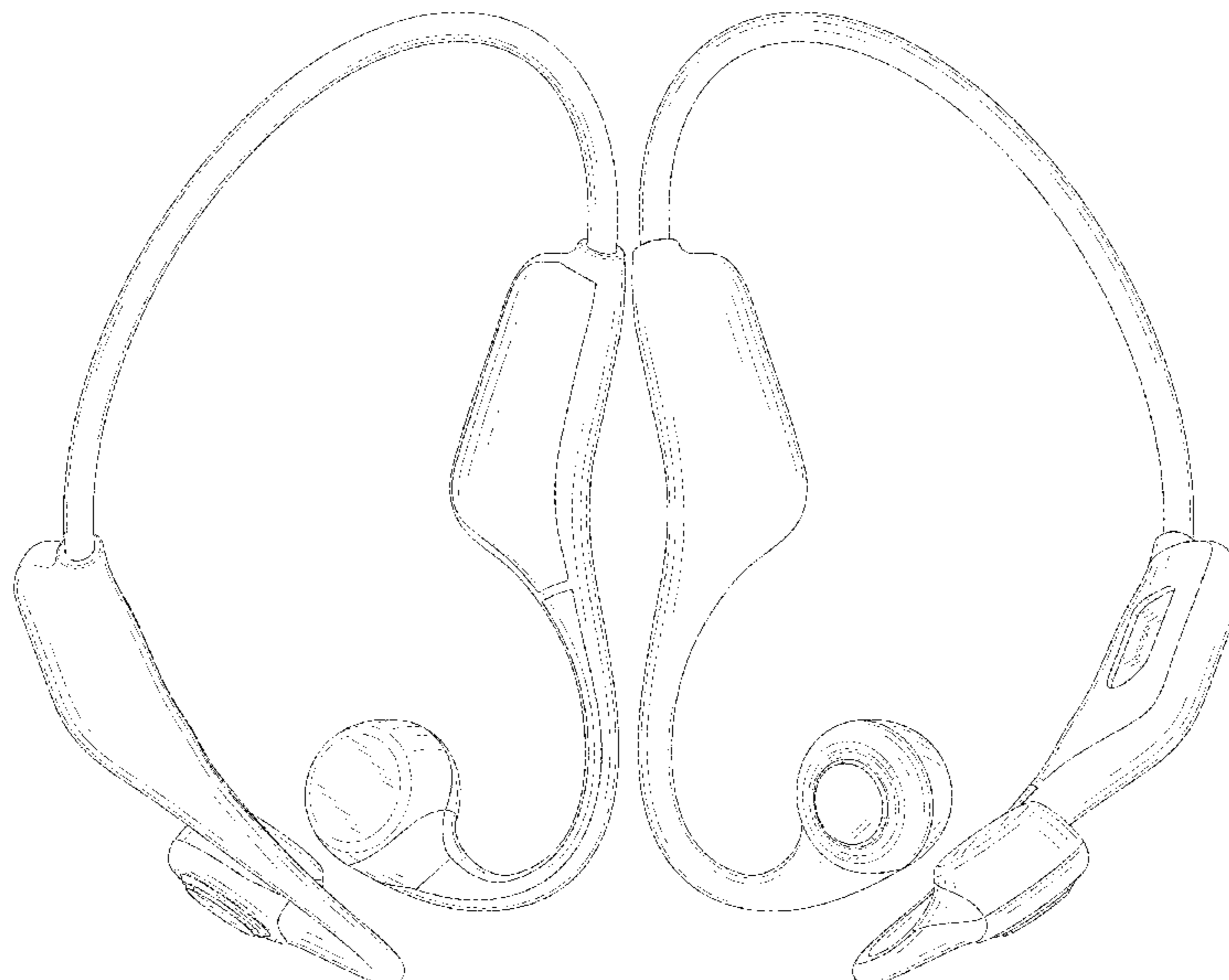
(57) **CLAIM**

The ornamental design for a bone conduction earphone, as shown and described.

DESCRIPTION

FIG. 1 is a rear perspective view of a bone conduction earphone showing my new design;
FIG. 2 is a front perspective view thereof;
FIG. 3 is a front view thereof;
FIG. 4 is a rear view thereof;
FIG. 5 is a left side view thereof;
FIG. 6 is a right side view thereof;
FIG. 7 is a top view thereof; and,
FIG. 8 is a bottom view thereof.
The broken lines illustrate portions of the bone conduction earphone that forms no part of the claimed design.

1 Claim, 8 Drawing Sheets



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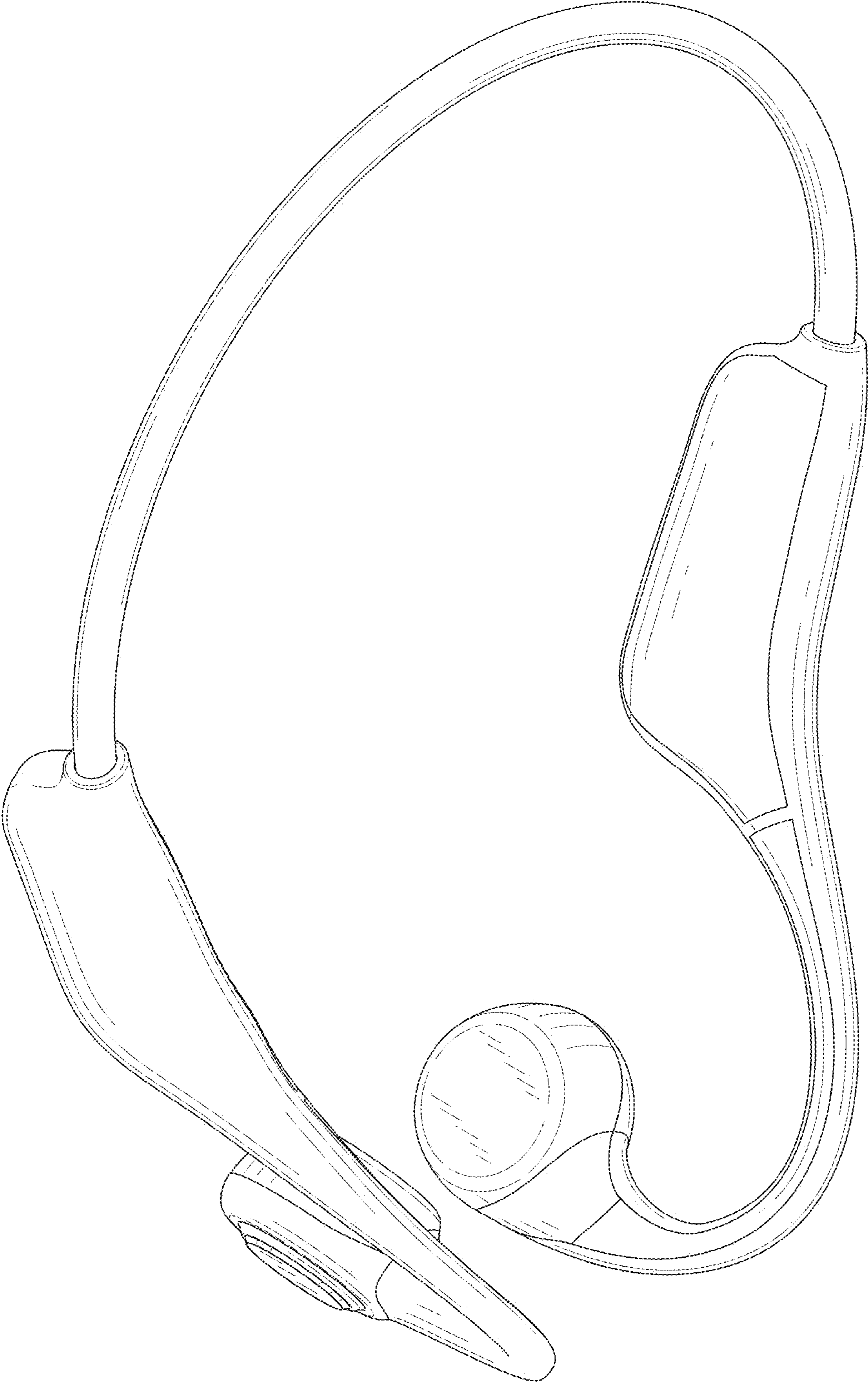


FIG. 1



FIG. 2



FIG. 3



FIG. 4

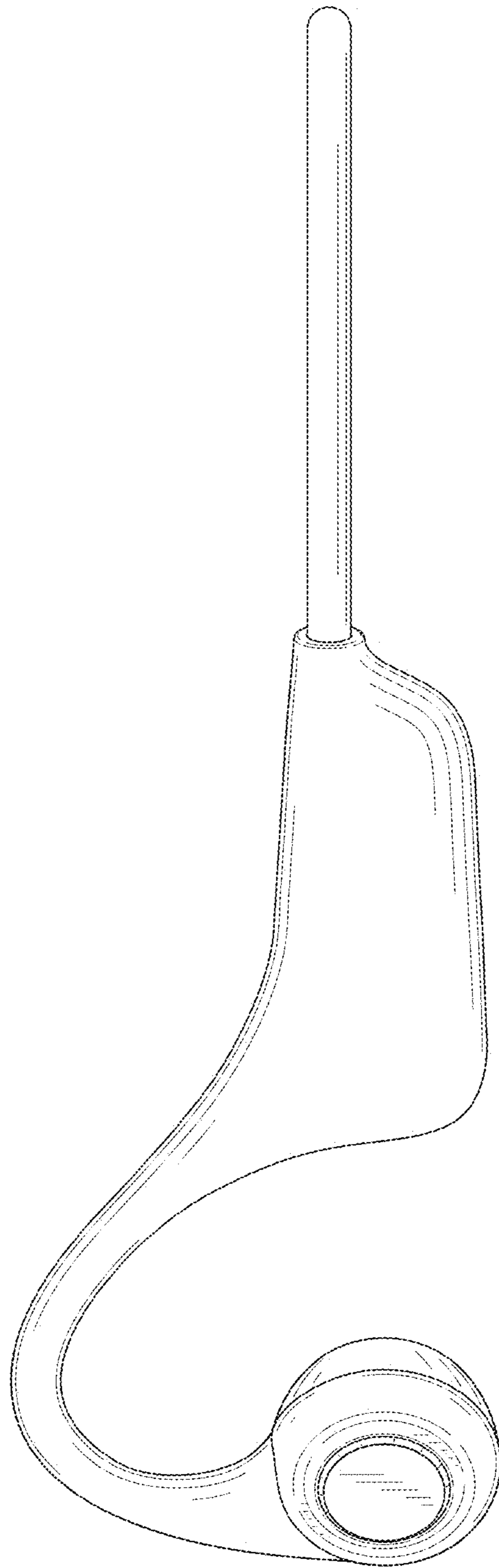


FIG. 5

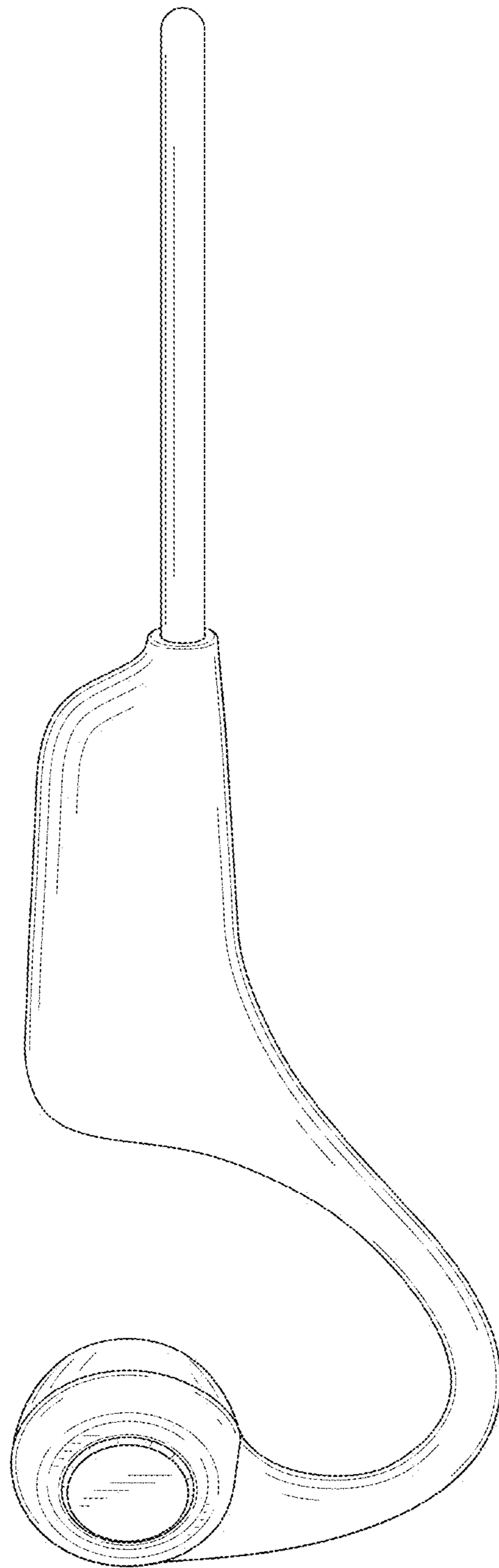


FIG. 6

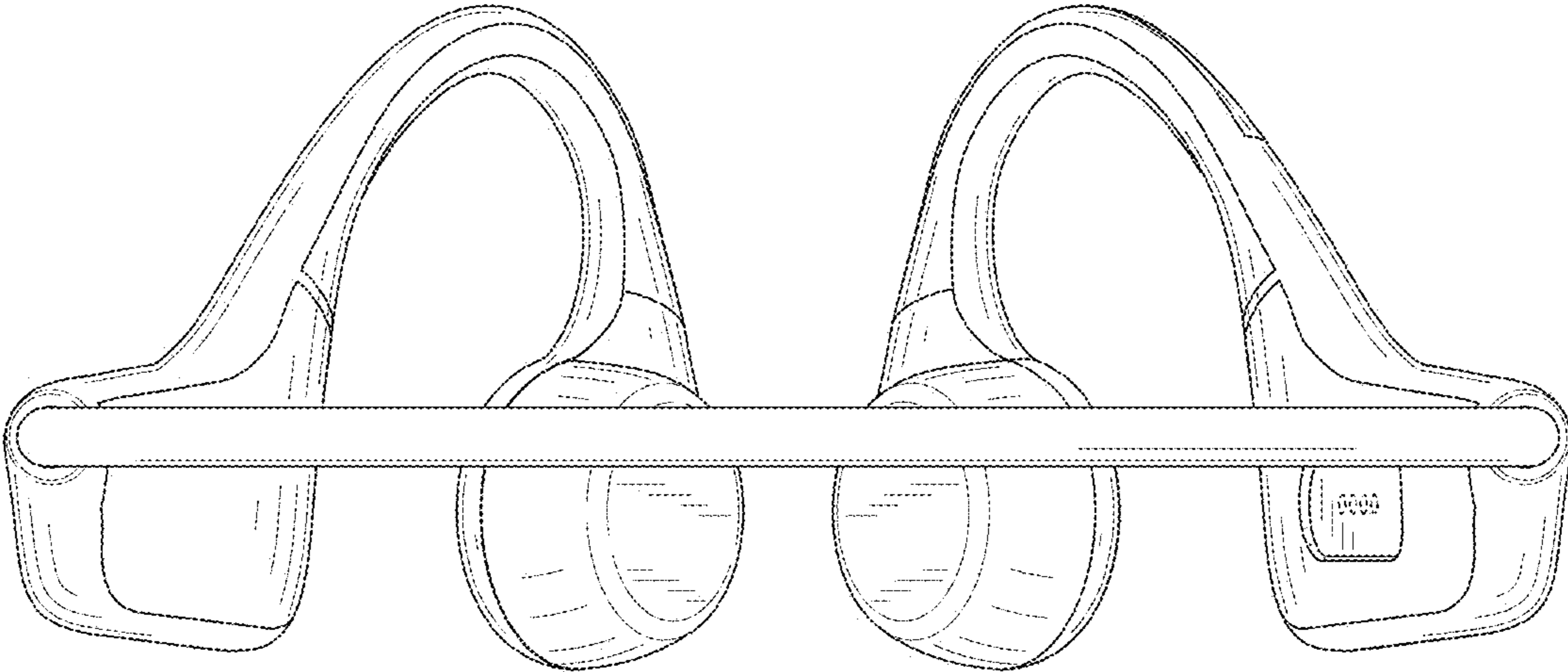


FIG. 7

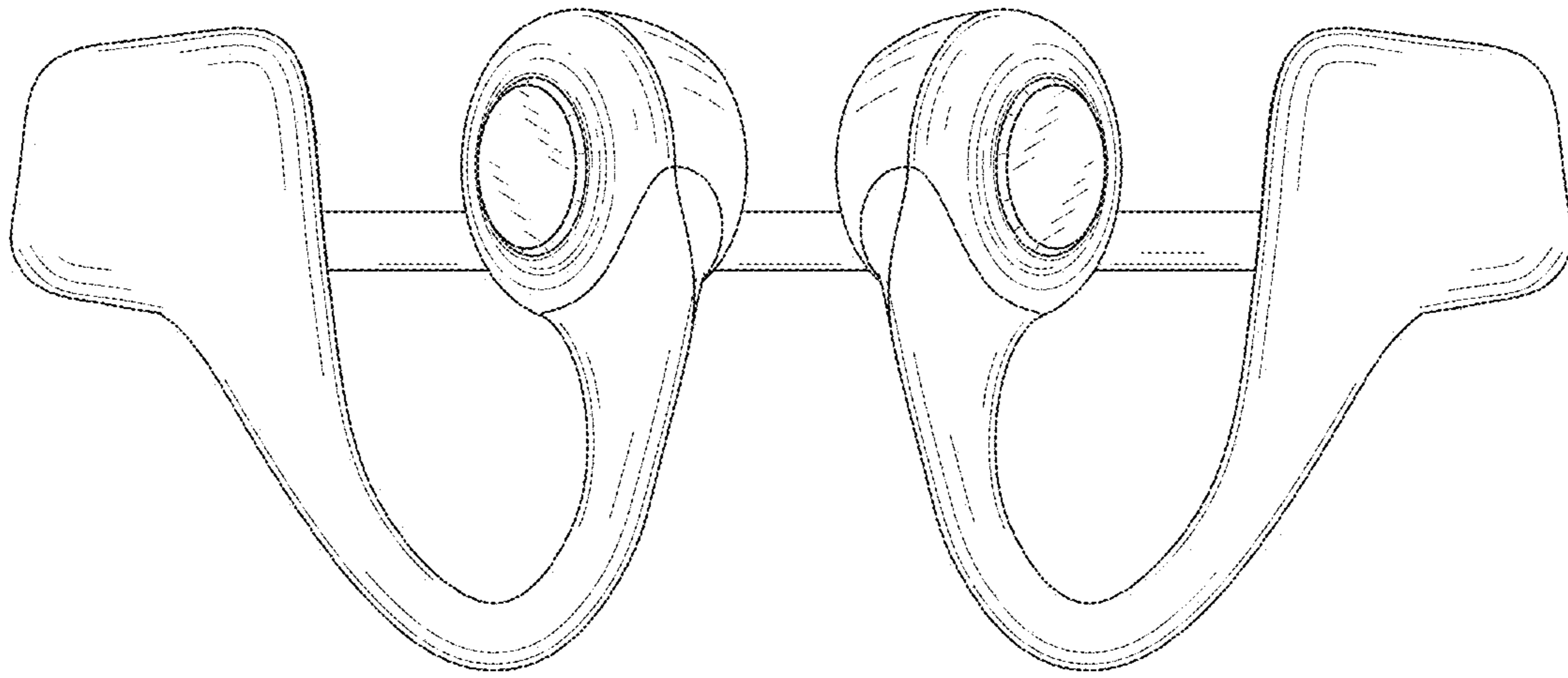


FIG. 8